



# Bill of Materials

TI DESIGNS

TIDA-00190

Fitted	Description	Designator	Manufacturer	PartNumber	Quantity	RoHS	PackageReference
Fitted	Printed Circuit Board	IPCB1	Any	ISE5002	1	O	
Fitted	CAP, CERM, 15pF, 50V, +/-5%, C0G/NP0, 0402	C8	MuRata	GRM1555C1H150JA01D	1	Y	0402
Fitted	CAP, CERM, 10uF, 35V, +/-10%, X7R, 1206	C13	Taiyo Yuden	GMK316AB7106KL	1	Y	1206
Fitted	CAP, CERM, 33pF, 50V, +/-5%, C0G/NP0, 0603	C16, C21	AVX	06035A330JAT2A	2	Y	0603
Fitted	CAP, CERM, 100pF, 50V, +/-10%, X7R, 0402	C17, C25, C32	Yageo America	CC0402KRX7R9BB101	3	Y	0402
Fitted	CAP, TA, 100uF, 10V, +/-20%, 0.6 ohm, SMD	C18, C29	Vishay-Sprague	293D107X0010D2TE3	2	Y	7343-31
Fitted	CAP, CERM, 0.01uF, 50V, +/-10%, C0G/NP0, 0402	C20, C48, C54	MuRata	GCM155R71H103KA55D	3	Y	0402
Fitted	CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0603	C22, C47, C53, C55	Kemet	C0603C104K4RACTU	4	Y	0603
Fitted	CAP, CERM, 0.1uF, 10V, +/-10%, X5R, 0402	C23, C26, C36, C37	TDK	C1005X5R1A104K	4	Y	0402
Fitted	CAP, CERM, 1uF, 6.3V, +/-10%, X5R, 0603	C27, C31, C33, C34	MuRata	GRM185R60J105KE26D	4	Y	0603
Fitted	CAP, CERM, 1000pF, 25V, +/-10%, X5R, 0402	C28, C50, C52	MuRata	GRM155R61E102KA01D	3	Y	0402
Fitted	CAP, CERM, 10uF, 10V, +/-10%, X5R, 1210	C30	Kemet	C1210C106K8PACTU	1	Y	1210
Fitted	CAP, CERM, 0.22uF, 16V, +/-10%, X7R, 0603	C35	MuRata	GRM188R71C224KA01D	1	Y	0603
Fitted	CAP, CERM, 1000pF, 2000V, +/-10%, X7R, 1812	C38, C39	AVX	1812GC102KA1	2	Y	1812
Fitted	CAP, CERM, 4700pF, 2000V, +/-10%, X7R, 1812	C40	AVX	1812GC472KA1	1	Y	1812
Fitted	Diode, Schottky, 200V, 1A, PowerDI123	D1, D2	Diodes Inc.	DFLS1200-7	2	Y	PowerDI123
Fitted	Quad Channel High Speed ESD Protection Device, DCK0006A	D3	Texas Instruments	TPD4E1U06DCK	1	Y	DCK0006A
Fitted	Diode, Zener, 3.9V, 550mW, SMB	D4	ON Semiconductor	1SMB5915BT3G	1	Y	SMB
Fitted	FERRITE CHIP 1000 OHM 300MA 0603	FB4	TDK Corporation	MMZ1608B102C	1	Y	0603
Fitted	CONN TERM BLOCK 2.54MM 2POS PCB	J1	On Shore Technology Inc	OSTVN02A150	1	Y	TERM_BLK, 2pos, 2.54mm
Fitted	CONN MOD JACK R/A 8P8C SHIELDED	J3	TE Connectivity	6116526-1	1		RJ45
Fitted	Receptacle, 0.8mm, 25x2, SMT	J4	Samtec	ERF8-025-05.0-L-DV-K-TR	1	Y	25x2 Socket Strip
Fitted	LED SmartLED Green 570NM	LD1, LD2, LD3, LD4, LD5	OSRAM	LG L29K-G2J1-24-Z	5		0603
Fitted	Mountin hole, NPTH Drill 3.2mm	MH1, MH2, MH3, MH4	N/A	N/A	4		
Fitted	RES, 33 ohm, 5%, 0.063W, 0402	R1, R2, R3, R4, R5, R6, R7, R8, R10, R11, R13, R23, R24, R25, R26, R27, R28, R62	Vishay-Dale	CRCW040233R0JNED	18	Y	0402
Fitted	RES, 0 ohm, 5%, 0.1W, 0603	R17, R19, R33, R35, R41, R44, R45, R47, R51, R53, R61, R79	Vishay-Dale	CRCW06030000Z0EA	12	Y	0603
Fitted	RES, 0 ohm, 5%, 0.125W, 0805	R21, R30, R34, R38	Yageo America	RC0805JR-070RL	4	Y	0805
Fitted	RES, 470 ohm, 1%, 0.1W, 0603	R32, R49, R76, R80, R83	Yageo America	RC0603FR-07470RL	5	Y	0603
Fitted	RES, 49.9 ohm, 1%, 0.063W, 0402	R39, R40, R42, R43	Vishay-Dale	CRCW040249R9FKED	4	Y	0402
Fitted	RES, 3.3k ohm, 5%, 0.063W, 0402	R48	Vishay-Dale	CRCW04023K30JNED	1	Y	0402
Fitted	RES, 2.2k ohm, 5%, 0.063W, 0402	R50, R64, R65, R66, R67, R69, R70, R75, R77, R81, R82	Vishay-Dale	CRCW04022K20JNED	11	Y	0402
Fitted	RES, 75.0 ohm, 1%, 0.1W, 0603	R54, R55, R56, R57	Yageo America	RC0603FR-0775RL	4	Y	0603
Fitted	RES, 1.0Meg ohm, 5%, 0.25W, 1206	R58	Vishay-Dale	CRCW12061M00JNEA	1	Y	1206
Fitted	RES, 4.87k ohm, 1%, 0.1W, 0603	R73	Vishay-Dale	CRCW06034K87FKEA	1	Y	0603
Fitted	RES, 2.00k ohm, 1%, 0.063W, 0402	R74	Vishay-Dale	CRCW04022K00FKED	1	Y	0402

Fitted	TRANSFORMER, MDL, XFMR SGL ETHR LAN, SOIC-16	T1	PULSE ELECTRONICS	HX1198FNL	1	Y	-
Fitted	IC, INDUSTRIAL TEMP, SINGLE PORT 10/100Mbps ETHERNET PHYSICAL LAYER TRANSCEIVER, VQFN-32P	U3	TEXAS INSTRUMENTS	TLK105LRHBR	1	Y	-
Fitted	IC, Low Dropout Voltage Regulator, 3.3 V, 2.0 A	U4	Texas Instruments	TPS75433QPWP	1		PWP20
Fitted	3.3 V and 2.5 V LVCMOS High-Performance Clock Buffer Family, PW0008A	U5	Texas Instruments	CDCLVC1102PW	1	Y	PW0008A
Fitted	CRYSTAL 25.0MHZ 18PF SMD	Y2	CTS-Frequency Controls	445I23D25M00000	1	Y	2-SMD
Not Fitted	CAP, CERM, 1uF, 10V, +/-10%, X5R, 1206	C1, C4	MuRata	GRM319R61A105KA01D	0	Y	1206
Not Fitted	CAP, CERM, 0.22uF, 6.3V, +/-10%, X7R, 0603	C2, C7, C44	MuRata	GRM188R70J224KA88D	0	Y	0603
Not Fitted	CAP, CERM, 33pF, 50V, +/-5%, C0G/NP0, 0603	C3, C9	AVX	06035A330JAT2A	0	Y	0603
Not Fitted	CAP, CERM, 0.1uF, 16V, +80/-20%, Y5V, 0603	C5	Kemet	C0603C104Z4VACTU	0	Y	0603
Not Fitted	CAP, CERM, 10uF, 35V, +/-10%, X7R, 1206	C6, C24	Taiyo Yuden	GMK316AB7106KL	0	Y	1206
Not Fitted	CAP, CERM, 0.01uF, 50V, +/-10%, C0G/NP0, 0402	C10, C15	MuRata	GCM155R71H103KA55D	0	Y	0402
Not Fitted	CAP, CERM, 15pF, 50V, +/-5%, C0G/NP0, 0402	C11, C49	MuRata	GRM1555C1H150JA01D	0	Y	0402
Not Fitted	CAP, CERM, 100pF, 50V, +/-10%, X7R, 0402	C12, C14	Yageo America	CC0402KRX7R9BB101	0	Y	0402
Not Fitted	CAP, CERM, 1000pF, 25V, +/-10%, X5R, 0402	C19, C42, C46	MuRata	GRM155R61E102KA01D	0	Y	0402
Not Fitted	CAP, CERM, 4.7uF, 6.3V, +/-10%, X5R, 0603	C41, C43, C45	Kemet	C0603C475K9PACTU	0	Y	0603
Not Fitted	CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0603	C51	Kemet	C0603C104K4RACTU	0	Y	0603
Not Fitted	FERRITE CHIP 1000 OHM 300MA 0603	FB1, FB2, FB3	TDK Corporation	MMZ1608B102C	0	Y	0603
Not Fitted	Fiducial mark. There is nothing to buy or mount.	FID1, FID2, FID3, FID4, FID5, FID6	N/A	N/A	0		Fiducial
Not Fitted	CONN HEADER 3POS 2MM VERT T/H	J2	3M	951103-8622-AR	0	Y	0.079 inch x 3
Not Fitted	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	LBL1	Brady	THT-14-423-10	0	Y	PCB Label 0.650"H x 0.200"W
Not Fitted	RES, 1.00Meg ohm, 1%, 0.063W, 0402	R9, R36	Vishay-Dale	CRCW04021M00FKED	0	Y	0402
Not Fitted	RES, 0 ohm, 5%, 0.1W, 0603	R12, R18, R29, R46, R52, R78	Vishay-Dale	CRCW06030000Z0EA	0	Y	0603
Not Fitted	RES, 22 ohm, 5%, 0.063W, 0402	R14, R15	Vishay-Dale	CRCW040222R0JNED	0	Y	0402
Not Fitted	RES, 2.2k ohm, 5%, 0.063W, 0402	R16, R63, R68, R71, R72	Vishay-Dale	CRCW04022K20JNED	0	Y	0402
Not Fitted	RES, 0 ohm, 5%, 0.125W, 0805	R20, R37	Yageo America	RC0805JR-070RL	0	Y	0805
Not Fitted	RES, 4.7k ohm, 5%, 0.1W, 0603	R31, R59, R60	Yageo America	RC0603JR-074K7L	0	Y	0603
Not Fitted	IC REG LDO 1.8V 50MA SC70-5	U1	TI	TPS71518DCKR	0		SOP-5 (DCK)
Not Fitted	Programmable 1-PLL VCXO Clock Synthesizer With 1.8-V, 2.5-V, and 3.3-V Outputs, PW0014A	U2	Texas Instruments	CDCE913PW	0	Y	PW0014A
Not Fitted	OSC 25.00 MHZ 3.3V HIGH STAB SMD	X1	EPSON	HG-2150CA 25.00M-BXC3	0	Y	4-SMD, No Lead (DFN, LCC)
Not Fitted	CRYSTAL 25.0MHZ 18PF SMD	Y1	CTS-Frequency Controls	445I23D25M00000	0	Y	2-SMD

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